COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: TIDA-00176_REVE1_production

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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: TIDA-00176</th>
<th>REV: Rev E1</th>
<th>SUN REV: Not In VersionControl</th>
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<td>GENERATED : 6/3/2015 10:16:35 AM</td>
<td>TEXAS INSTRUMENTS</td>
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